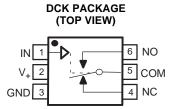


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10-Ω SPDT ANALOG SWITCH SINGLE-CHANNEL 2:1 MULTIPLEXER/DEMULTIPLEXER

FEATURES

- 2.25-V to 5.5-V Single-Supply Operation
- Low ON-State Resistance (10 Ω Max at V₊ = 5V)
- Specified Break-Before-Make Switching
- Low Power Consumption
- TTL/CMOS Compatible Control Input
- Low Input/Output Capacitance
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)
- Control Inputs Are 5.5-V Tolerant
- Excellent ON-State Resistance Matching
- Low Total Harmonic Distortion (THD)



APPLICATIONS

- Cell Phones
- Communication Systems
- Portable Test Equipment
- Battery Operated Systems
- Sample-and-Hold Circuits

DESCRIPTION

The TS5A9411 is a single-pole double-throw (SPDT) analog switch that is designed to operate from 2.25 V to 5.5 V. The device offers low ON-state resistance, low leakage, and low power with a break-before-make feature. These features make this device suitable for portable and battery-powered applications.

FUNCTION TABLE

IN	NC TO COM, COM TO NC	NO TO COM, COM TO NO
L	ON	OFF
н	OFF	ON

ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING ⁽³⁾	
–40°C to 85°C	SOT (SC-70) – DCK	Tape and reel	TS5A9411DCKR	32_	

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

(3) DCK: The actual top-side marking has one additional character that designates the assembly/test site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



Configuration	2:1 Multiplexer/ Demultiplexer (1 × SPDT)			
Number of channels	1			
ON-state resistance (r _{ON})	5.3 Ω			
ON-state resistance match (Δr_{ON})	0.03 Ω			
ON-state resistance flatness r _{ON(flat)})	2 Ω			
Turn-on/turn-off time (t _{ON/tOFF})	9 ns/7 ns			
Break-before-make time (t _{BBM})	1 ns			
Charge injection (Q _C)	12.5 pC			
Bandwidth (BW)	100 MHz			
OFF isolation (O _{ISO})	–84 dB at 1 MHz			
Crosstalk (X _{TALK})	–85 dB at 1 MHz			
Total harmonic distortion (THD)	0.03%			
Leakage current (I _{NO(OFF)} /I _{NC(OFF)})	±3 nA			
Power-supply current (I ₊)	0.01 µA			
Package options	6-pin DCK			

SUMMARY OF CHARACTERISTICS⁽¹⁾

(1) $V_+ = 5 V, T_A = 25^{\circ}C$

ABSOLUTE MINIMUM AND MAXIMUM RATINGS⁽¹⁾⁽²⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V+	Supply voltage range ⁽³⁾		-0.3	6	V
V _{NO} V _{NC} V _{COM}	Analog voltage range ⁽³⁾⁽⁴⁾⁽⁵⁾	-0.3	V ₊ + 0.3	V	
Ι _Κ	Analog port diode current	$V_{NC}, V_{NO}, V_{COM} < 0$	-50		mA
I _{NO}	On-state switch current		-50	50	mA
I _{NC} I _{COM}	On-state peak switch current ⁽⁶⁾	V_{NO} , V_{NC} , $V_{COM} = 0$ to V_+	-200	200	
VI	Digital input voltage range ⁽³⁾⁽⁴⁾		-0.5	V ₊ + 0.3	V
I _{IK}	Digital input clamp current	V ₁ < 0	-50		mA
l+	Continuous current through V ₊		100	mA	
I _{GND}	Continuous current through GND		-100		mA
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

(3) All voltages are with respect to ground, unless otherwise specified.

(4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

(5) This value is limited to 5.5 V maximum.

(6) Pulse at 1-ms duration < 10% duty cycle

THERMAL IMPEDANCE RATINGS

				UNIT
θ_{JA}	Package thermal impedance ⁽¹⁾	DCK package	259	°C/W

(1) The package thermal impedance is calculated in accordance with JESD 51-7.

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ELECTRICAL CHARACTERISTICS FOR 5-V SUPPLY⁽¹⁾

 V_{\star} = 4.5 V to 5.5 V, T_{A} = –40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	ITIONS	TA	V.	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		V ₊	V
ON-state	r	V_{NO} or $V_{NC} = 3 V$,	Switch ON,	25°C	- 4.5 V		5.3	9	Ω
resistance	r _{ON}	$I_{COM} = -10 \text{ mA},$	See Figure 6	Full	4.5 V			10	52
ON-state				25°C			0.03	0.3	_
resistance match between channels	Δr_{ON}	V_{NO} or $V_{NC} = 3 V$, $I_{COM} = -10 \text{ mA}$,	Switch ON, See Figure 6	Full	4.5 V			0.3	Ω
ON-state resistance flatness	r _{ON(flat)}	$\begin{array}{l} 0 \leq (V_{\text{NO}} \text{ or } V_{\text{NC}}) \leq V_{+}, \\ I_{\text{COM}} = -10 \text{ mA}, \end{array}$	Switch ON, See Figure 6	25°C	4.5 V		2		Ω
		V_{NC} or $V_{NO} = 1 V$,		25°C		-500		500	pА
NC, NO OFF leakage current	I _{NC(OFF)} , I _{NO(OFF)}	$V_{COM} = 1 V \text{ to } 4.5 V,$ or $V_{NC} \text{ or } V_{NO} = 4.5 V,$ $V_{COM} = 1 V,$	Switch OFF, See Figure 7	Full	5.5 V	-3		3	nA
NC, NO		V_{NC} or $V_{NO} = 1 V$,		25°C		-500		500	pА
ON leakage current	I _{NC(ON)} , I _{NO(ON)}	$V_{COM} = 1 V$ $V_{NC} \text{ or } V_{NO} = 4.5 V$, $V_{COM} = 4.5 V$,	Switch ON, See Figure 8	Full	5.5 V	-3		3	nA
		V_{NC} or V_{NO} = Open,		25°C		-500		500	pА
COM ON leakage current	I _{COM(ON)}	$\label{eq:VCOM} \begin{array}{l} V_{COM} = 1 \ V, \\ \text{or} \\ V_{NC} \ \text{or} \ V_{NO} = \text{Open}, \\ V_{COM} = 4.5 \ V, \end{array}$	Switch ON, See Figure 8	Full	5.5 V	-3		3	nA
Digital Input (IN)									
Input logic high	M			Full	4.5 V to 5.5 V	2.4		5.5	v
Input logic high	V _{IH}			Full	4.5 V	2		5.5	v
Input logic low	V _{IL}			Full	4.5 V to 5.5 V	0		0.8	V
Input leakage	lus lu	V ₁ = 5.5 V or 0		25°C	- 5.5 V	-0.05		0.05	
current	I _{IH} , I _{IL}	v] = 3.3 v 0i 0		Full	0.0 V	-0.05		0.05	μA

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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ELECTRICAL CHARACTERISTICS FOR 5-V SUPPLY (continued)

 V_{\star} = 4.5 V to 5.5 V, T_{A} = –40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDI	TIONS	T _A	V.	MIN	TYP	MAX	UNIT
Dynamic									
-		$V_{COM} = 3 V,$	$C_{1} = 35 \text{pF},$	25°C	5 V			9	
Turn-on time	t _{ON}	$R_L = 300 \Omega,$	See Figure 10	Full	4.5 V to 5.5 V			10	ns
Turn-off time	+	$V_{COM} = 3 V,$	C _L = 35 pF,	25°C	5 V			7	20
rum-on ume	t _{OFF}	$R_L = 300 \Omega$,	See Figure 10	Full	4.5 V to 5.5 V			7.5	ns
Break-before-	+	$V_{NC} = V_{NO} = 3 V,$	C _L = 35 pF,	25°C	- 5 V	1			-
make time	t _{BBM}	$R_L = 300 \Omega$,	See Figure 11	Full	5 V	0.9			ns
Charge injection	Q _C	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C _L = 1 nF, See Figure 15	25°C	5 V		12.5		рС
NC, NO OFF capacitance	$\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$	V_{NC} or $V_{NO} = V_{+}$ or GND, f = 1 MHz,	Switch OFF, See Figure 9	25°C	5 V		3.5		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, f = 1 MHz,	See Figure 9	25°C	5 V		8.5		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_+ \text{ or GND},$ f = 1 MHz,	Switch ON, See Figure 9	25°C	5 V		8.5		pF
Digital input capacitance	CI	$V_1 = V_+ \text{ or GND},$ f = 1 MHz,	See Figure 9	25°C	5 V		25		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 12	25°C	5 V		100		MHz
OFF isolation	O _{ISO}		Switch OFF, See Figure 13	25°C	5 V		-84		dB
Crosstalk	X _{TALK}		Switch ON, See Figure 14	25°C	5 V		-85		dB
Total harmonic distortion	THD		f = 20 Hz to 20 kHz, See Figure 16	25°C	5 V		0.03		%
Supply					· · ·				
Positive supply	I	$V_1 = V_+$ or GND,	Switch ON or	25°C	- 5.5 V		0.01		
current	I+	$v_{\rm I} = v_+$ or GIND,	OFF	Full	5.5 V			0.5	μA



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ELECTRICAL CHARACTERISTICS FOR 3-V SUPPLY⁽¹⁾

 V_{\star} = 2.7 V to 3.3 V, T_{A} = –40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CON	DITIONS	T _A	۷.	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		V+	V
ON-state	r	V_{NO} or V_{NC} = 1.5 V,	Switch ON,	25°C	2.7 V		11.5	15	Ω
resistance	r _{ON}	$I_{COM} = -10 \text{ mA},$	See Figure 6	Full	2.7 V			20	12
ON-state				25°C			0.05	0.3	
resistance match between channels	∆r _{ON}	V_{NO} or V_{NC} = 1.5 V, I_{COM} = -10 mA,	Switch ON, See Figure 6	Full	2.7 V			0.3	Ω
ON-state resistance flatness	r _{ON(flat)}	$\begin{array}{l} 0 \leq (V_{\rm NO} \mbox{ or } V_{\rm NC}) \leq V_+, \\ I_{\rm COM} = -10 \mbox{ mA}, \end{array}$	Switch ON, See Figure 6	25°C	3 V		2		Ω
		V_{NC} or V_{NO} = 1 V,		25°C		-400		400	pА
NC, NO OFF leakage current	I _{NC(OFF)} , I _{NO(OFF)}	$V_{COM} = 1 V \text{ to } 3 V,$ or $V_{NC} \text{ or } V_{NO} = 3 V,$ $V_{COM} = 1 V,$	Switch OFF, See Figure 7	Full	3.3V	-2		2	nA
NC, NO		V_{NC} or $V_{NO} = 1 V$,		25°C		-400		400	pА
ON leakage current	I _{NC(ON)} , I _{NO(ON)}		Switch ON, See Figure 8	Full	3.3 V	-2		2	nA
		V_{NC} or V_{NO} = Open,		25°C		-400		400	pА
COM ON leakage current	I _{COM(ON)}	$\label{eq:VCOM} \begin{array}{l} V_{COM} = 1 \ V, \\ \text{or} \\ V_{NC} \ \text{or} \ V_{NO} = \text{Open}, \\ V_{COM} = 3 \ V, \end{array}$	Switch ON, See Figure 8	Full	3.3 V	-2		2	nA
Digital Input (IN)									
Input logic high	V _{IH}			Full		2		5.5	V
Input logic low	V _{IL}			Full		0		0.8	V
Input leakage		$\mathcal{V} = \mathbf{F} \mathbf{F} \mathcal{V} \mathbf{or} 0$		25°C	3.6 V	-0.05		0.05	
current	I _{IH} , I _{IL}	$V_1 = 5.5 V \text{ or } 0$		Full	3.0 V	-0.05		0.05	μA

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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ELECTRICAL CHARACTERISTICS FOR 3-V SUPPLY (continued)

 V_{\star} = 2.7 V to 3.3 V, T_{A} = –40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	ITIONS	TA	V.	MIN	TYP	MAX	UNIT
Dynamic									
-		$V_{COM} = 3 V,$	$C_{1} = 35 \text{ pF},$	25°C	3 V			13	
Turn-on time	t _{ON}	$R_L = 300 \Omega,$	See Figure 10	Full	2.7 V to 3.3 V			15	ns
Turn-off time	+	$V_{COM} = 3 V,$	C _L = 35 pF,	25°C	3.3 V			7.5	20
rum-on ume	t _{OFF}	$R_L = 300 \Omega$,	See Figure 10	Full	2.7 V to 3.3 V			8.5	ns
Break-before-	+	$V_{NC} = V_{NO} = 3 V,$	C _L = 35 pF,	25°C	- 3.3 V	1			20
make time	t _{BBM}	$R_L = 300 \Omega$,	See Figure 11	Full	3.3 V	0.9			ns
Charge injection	Q_C		C _L = 1 nF, See Figure 15	25°C	3 V		6		рС
NC, NO OFF capacitance	$\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$	V_{NC} or $V_{NO} = V_{+}$ or GND, f = 1 MHz,	Switch OFF, See Figure 9	25°C	3 V		3.5		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, f = 1 MHz,	Switch OFF, See Figure 9	25°C	3 V		8.5		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_+ \text{ or GND},$ f = 1 MHz,	Switch OFF, See Figure 9	25°C	3 V		8.5		pF
Digital input capacitance	Cl	$V_I = V_+ \text{ or GND},$ f = 1 MHz,	See Figure 9	25°C	3 V		2.5		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 12	25°C	3 V		100		MHz
OFF isolation	O _{ISO}	$\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$	Switch OFF, See Figure 13	25°C	3 V		-84		dB
Crosstalk	X _{TALK}	$\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$	Switch ON, See Figure 14	25°C	3 V		-85		dB
Total harmonic distortion	THD	$ \begin{array}{l} R_{L} = 600 \ \Omega, \\ C_{L} = 50 \ pF, \end{array} $	f = 20 Hz to 20 kHz, See Figure 16	25°C	3 V		0.09		%
Supply									
Positive supply	I+	$V_1 = V_+$ or GND,	Switch ON or	25°C	- 3.6 V		0.01		μA
current	·+	$v_1 = v_+$ or Give,	OFF	Full	3.0 v			0.5	μΑ



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ELECTRICAL CHARACTERISTICS FOR 2.5-V SUPPLY⁽¹⁾

 $V_{+} = 2.25 \text{ V}$ to 2.75, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CON	DITIONS	T _A	V.	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		V+	V
ON-state	r	V_{NO} or $V_{NC} = 1 V$,	Switch ON,	25°C	2.25 V		15	25	Ω
resistance	r _{ON}	$I_{COM} = -10 \text{ mA},$	See Figure 6	Full	2.23 V			28	12
ON-state				25°C			0.06	0.3	
resistance match between channels	∆r _{ON}	V_{NO} or $V_{NC} = 1 V$, $I_{COM} = -10 \text{ mA}$,	Switch ON, See Figure 6	Full	2.25 V			0.3	Ω
ON-state resistance flatness	r _{ON(flat)}	$\begin{array}{l} 0 \leq (V_{NO} \text{ or } V_{NC}) \leq V_{+}, \\ I_{COM} = -10 \text{ mA}, \end{array}$	Switch ON, See Figure 6	25°C	2.25 V		4		Ω
		V_{NC} or V_{NO} = 1.5 V,		25°C		-300		300	pА
NC, NO OFF leakage current	I _{NC(OFF)} , I _{NO(OFF)}		Switch OFF, See Figure 7	Full	2.75 V	-1		1	nA
NC, NO		V_{NC} or V_{NO} = 1.5 V,		25°C		-300		300	pА
ON leakage current	I _{NC(ON)} , I _{NO(ON)}		Switch ON, See Figure 8	Full	2.75 V	-1		1	nA
		V_{NC} or V_{NO} = Open,		25°C		-300		300	pА
COM ON leakage current	I _{COM(ON)}	$\label{eq:VCOM} \begin{array}{l} V_{COM} = 0.5 \ \text{V}, \\ \text{or} \\ V_{NC} \ \text{or} \ \text{V}_{NO} = \text{Open}, \\ V_{COM} = 1.5 \ \text{V}, \end{array}$	Switch ON, See Figure 8	Full	2.75 V	-1		1	nA
Digital Input (IN)									
Input logic high	V _{IH}			Full		2		5.5	V
Input logic low	V _{IL}			Full		0		0.4	V
Input leakage	Lux Lu	$V_{\rm r} = 5.5 V_{\rm or} 0 V_{\rm r}$		25°C	2.75 V	-0.05		0.05	
current	I _{IH} , I _{IL}	$V_{I} = 5.5 V \text{ or } 0 V$		Full	2.13 V	-0.05		0.05	μA

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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ELECTRICAL CHARACTERISTICS FOR 2.5-V SUPPLY (continued)

 V_{\star} = 2.25 V to 2.75, T_{A} = –40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	ITIONS	TA	V.	MIN	TYP	MAX	UNIT
Dynamic									
		N 0.14	0 05 - 5	25°C	2.5 V			18	
Turn-on time	t _{ON}	$V_{COM} = 2 V, \\ R_{L} = 300 \Omega,$	C _L = 35 pF, See Figure 10	Full	2.25 V to 2.75 V			20	ns
		$\lambda = 2 \lambda $	C _L = 35 pF,	25°C	2.5 V			8	
Turn-off time	t _{OFF}	$V_{COM} = 2 V,$ R _L = 300 Ω,	$G_L = 35 \text{ pr},$ See Figure 10	Full	2.25 V to 2.75 V			9.5	ns
Break-before-		$V_{NC} = V_{NO} = 2 V$	$C_1 = 35 pF_2$	25°C	0.5.1/	1			
make time	t _{BBM}	$R_L = 300 \Omega$,	See Figure 11	Full	2.5 V	0.9			ns
Charge injection	Q _C	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C _L = 1 nF, See Figure 15	25°C	2.5 V		4.5		рС
NC, NO OFF capacitance	C _{NC(OFF)} , C _{NO(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, f = 1 MHz,	Switch OFF, See Figure 9	25°C	2.5 V		3.5		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, f = 1 MHz,	Switch OFF, See Figure 9	25°C	2.5 V		8.5		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_{+} \text{ or GND},$ f = 1 MHz,	Switch OFF, See Figure 9	25°C	2.5 V		8.5		pF
Digital input capacitance	C _i	$V_I = V_+ \text{ or GND},$ f = 1 MHz,	See Figure 9	25°C	2.5 V		2.5		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 12	25°C	2.5 V		100		MHz
OFF isolation	O _{ISO}	$ \begin{array}{l} R_L = 50 \ \Omega, \\ f = 1 \ MHz, \end{array} $	Switch OFF, See Figure 13	25°C	2.5 V		-84		dB
Crosstalk	X _{TALK}	$\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$	Switch ON, See Figure 14	25°C	2.5 V		-84		dB
Total harmonic distortion	THD	$ \begin{array}{l} R_{L} = 600 \ \Omega, \\ C_{L} = 50 \ pF, \end{array} $	f = 20 Hz to 20 kHz, See Figure 16	25°C	2.5 V		0.15		%
Positive supply	I	V = V or CND	Switch ON or	25°C	2.75 V		0.01		
current	I+	$V_1 = V_+ \text{ or GND},$	OFF	Full	2.15 V			0.5	μA

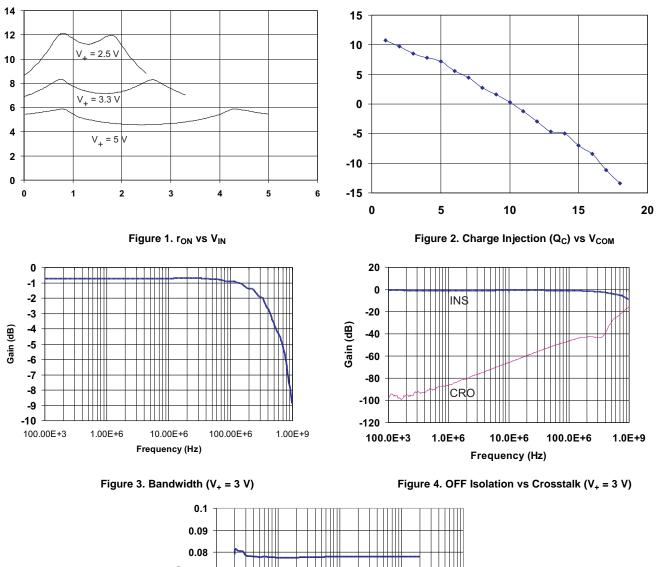
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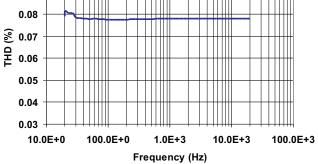


Figure 5. Total Harmonic Distortion vs Frequency

PIN NO.	NAME	DESCRIPTION
1	IN	Digital control to connect COM to NO
2	V+	Power supply
3	GND	Digital ground
4	NC	Normally closed
5	COM	Common
6	NO	Normally open

PIN DESCRIPTION

PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION
V _{COM}	Voltage at COM
V _{NC}	Voltage at NC
V _{NO}	Voltage at NO
r _{ON}	Resistance between COM and NC or COM and NO ports when the channel is ON
∆r _{ON}	Difference of r _{on} between channels
r _{ON(flat)}	Difference between the maximum and minimum value of ron in a channel over the specified range of conditions
I _{NC(OFF)}	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state under worst-case input and output conditions
I _{NO(OFF)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state under worst-case input and output conditions
I _{NC(ON)}	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) being open
I _{NO(ON)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) being open
I _{COM(ON)}	Leakage current measured at the COM port, with the corresponding channel (COM to NO or COM to NC) in the ON state and the output (NC or NO) being open
I _{COM(PWROFF)}	Leakage current measured at the COM port during the power-down condition, $V_{+} = 0$
V _{IH}	Minimum input voltage for logic high for the control input (IN)
V _{IL}	Maximum input voltage for logic low for the control input (IN)
VI	Voltage at IN
I _{IH} , I _{IL}	Leakage current measured at IN
t _{ON}	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog outputs (COM, NC, or NO) signal when the switch is turning ON.
t _{OFF}	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog outputs (COM, NC, or NO) signal when the switch is turning OFF.
t _{BBM}	Break-before-make time. This parameter is measured under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels (NC and NO) when the control signal changes state.
Q _C	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC, NO, or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_O$, C_L is the load capacitance and ΔVO is the change in analog output voltage.

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PARAMETER DESCRIPTION (continued)

SYMBOL	DESCRIPTION
C _{NC(OFF)}	Capacitance at the NC port when the corresponding channel (NC to COM) is OFF
C _{NO(OFF)}	Capacitance at the NO port when the corresponding channel (NO to COM) is OFF
C _{NC(ON)}	Capacitance at the NC port when the corresponding channel (NC to COM) is ON
C _{NO(ON)}	Capacitance at the NO port when the corresponding channel (NO to COM) is ON
C _{COM(ON)}	Capacitance at the COM port when the corresponding channel (COM to NC or COM to NO) is ON
CI	Capacitance of control input (IN)
O _{ISO}	OFF isolation of the switch is a measurement OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM or NO to COM) in the OFF state.
X _{TALK}	Crosstalk is a measurement of unwanted signal coupling from an ON channel to an OFF channel (NC to NO or NO to NC). This is measured in a specific frequency and in dB.
BW	Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.
THD	Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio or root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.
I+	Static power-supply current with the control (IN) pin at V ₊ or GND



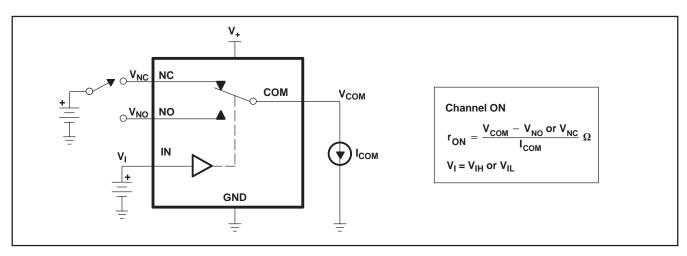
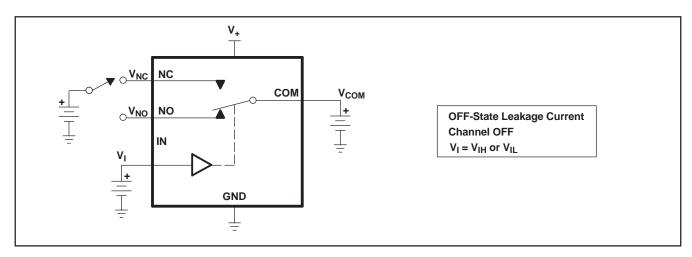


Figure 6. ON-State Resistance (ron)





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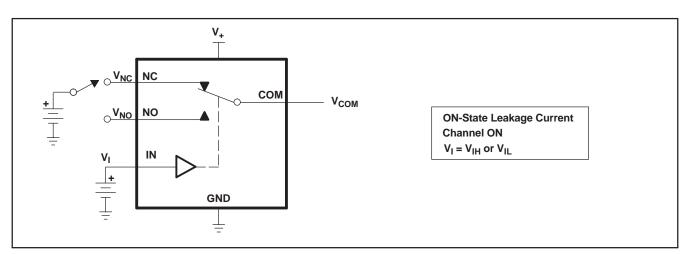


Figure 8. ON-State Leakage Current $(I_{COM(ON)}, I_{NC(ON)}, I_{NO(ON)})$

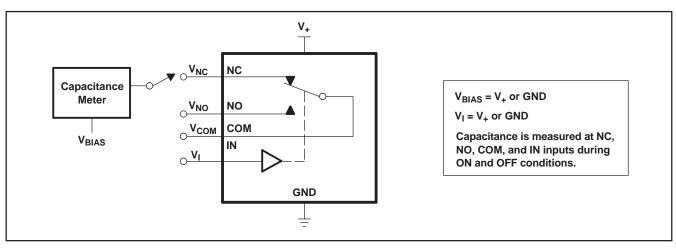
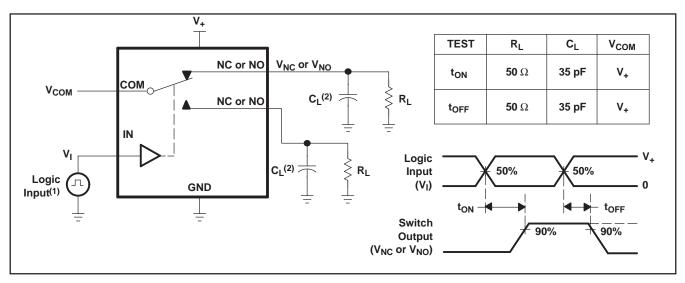


Figure 9. Capacitance (C₁, C_{COM(ON)}, C_{NC(OFF)}, C_{NO(OFF)}, C_{NC(ON)}, C_{NO(ON)})







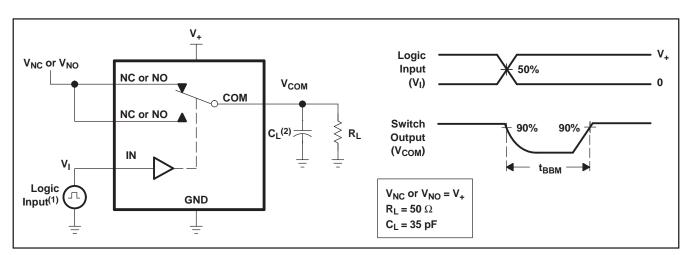
A. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z₀ = 50 Ω , t_r < 5 ns, t_f < 5 ns.

B. C_L includes probe and jig capacitance.

Figure 10. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

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- A. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r < 5 ns, t_f < 5 ns.
- B. C_L includes probe and jig capacitance.

Figure 11. Break-Before-Make Time (t_{BBM})

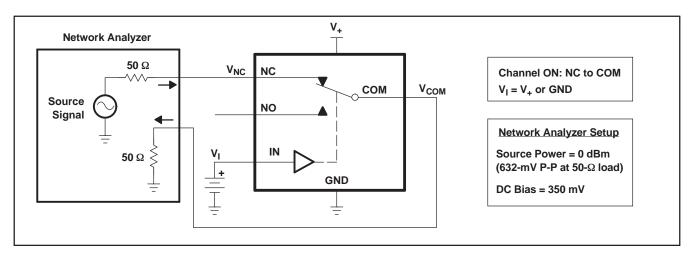
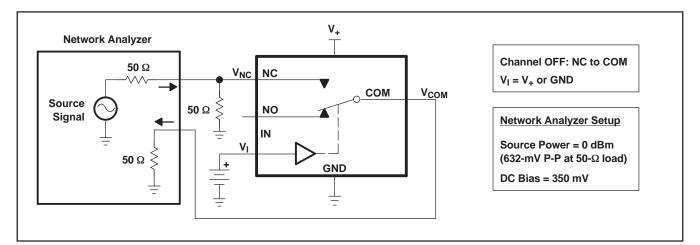
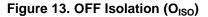


Figure 12. Bandwidth (BW)









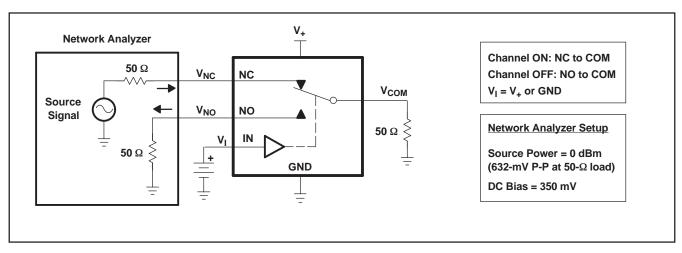
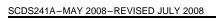


Figure 14. Crosstalk (X_{TALK})

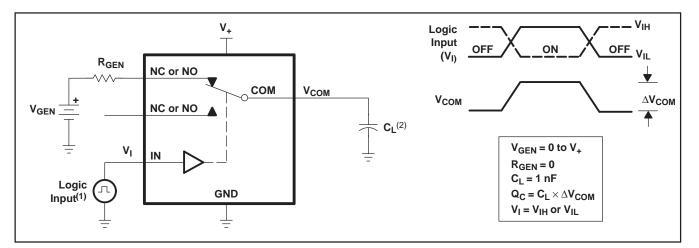
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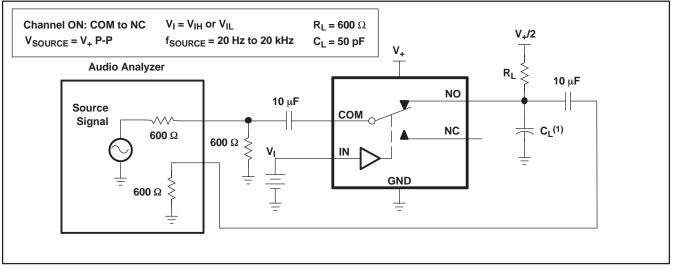
INSTRUMENTS

Texas



- A. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r < 5 ns, t_f < 5 ns.
- B. C_L includes probe and jig capacitance.

Figure 15. Charge Injection (Q_C)



A. C_L includes probe and jig capacitance.

Figure 16. Total Harmonic Distortion (THD)

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TS5A9411DCKR	ACTIVE	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TS5A9411DCKRG4	ACTIVE	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TS5A9411DCKT	ACTIVE	SC70	DCK	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TS5A9411DCKTG4	ACTIVE	SC70	DCK	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TS5A9411DCKR	SC70	DCK	6	3000	180.0	9.2	2.24	2.34	1.22	4.0	8.0	Q3
TS5A9411DCKT	SC70	DCK	6	250	180.0	9.2	2.24	2.34	1.22	4.0	8.0	Q3



PACKAGE MATERIALS INFORMATION

2-Jul-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TS5A9411DCKR	SC70	DCK	6	3000	202.0	201.0	28.0
TS5A9411DCKT	SC70	DCK	6	250	202.0	201.0	28.0

DCK (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-203 variation AB.



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